

2SK1951

Silicon N Channel MOS FET

Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for Switching regulator, DC – DC converter
- Avalanche ratings

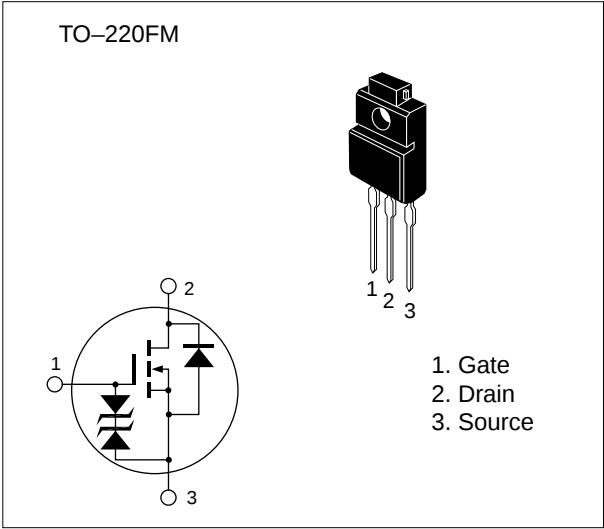


Table 1 Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	25	A
Drain peak current	$I_{D(pulse)^{*}}$	100	A
Body–drain diode reverse drain current	I_{DR}	25	A
Avalanche current	I_{AP}^{***}	25	A
Avalanche energy	E_{AR}^{***}	53	mJ
Channel dissipation	P_{ch}^{**}	30	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	–55 to +150	°C

* $PW \leq 10 \mu s$, duty cycle $\leq 1 \%$
** Value at $T_c = 25 \text{ }^{\circ}C$
*** Value at $T_{ch} = 25 \text{ }^{\circ}C$, $R_g \geq 50 \Omega$

Table 2 Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \text{ } \mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	250	μA	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.25	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.03	0.04	Ω	$I_D = 15 \text{ A}$ $V_{GS} = 10 \text{ V}^*$
		—	0.043	0.06	Ω	$I_D = 15 \text{ A}$ $V_{GS} = 4 \text{ V}^*$
Forward transfer admittance	$ y_{fs} $	12	21	—	S	$I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}^*$
Input capacitance	C_{iss}	—	1450	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	655	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	195	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$I_D = 15 \text{ A}$
Rise time	t_r	—	110	—	ns	$V_{GS} = 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	225	—	ns	$R_L = 2 \text{ } \Omega$
Fall time	t_f	—	145	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.2	—	V	$I_F = 25 \text{ A}$, $V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	100	—	ns	$I_F = 25 \text{ A}$, $V_{GS} = 0$, $diF / dt = 50 \text{ A} / \mu\text{s}$

* Pulse Test

See characteristics curves of 2SK1910

